

**Basic Details**

<b>Organisation Chain</b>	Indian Institute of Technology Madras  Deputy Registrar (Industrial Consultancy and Sponsored Research)		
<b>Tender Reference Number</b>	PHY/JKRA/006/2018		
<b>Tender ID</b>	2018_IIT-M_372440_1		
<b>Tender Type</b>	Open Tender	<b>Form of contract</b>	Supply
<b>Tender Category</b>	Goods	<b>No. of Covers</b>	2
<b>Payment Mode</b>	Not Applicable	<b>Is Multi Currency Allowed For BOQ</b>	No
<b>Is Multi Currency Allowed For Fee</b>	No		

**Cover Details, No. Of Covers - 2**

Cover No	Cover	Document Type	Description
1	Fee/PreQual/Technical	.pdf	Technical
2	Finance	.pdf	Financial

**Tender Fee Details, [Total Fee in ₹ \* - 0.00]**

<b>Tender Fee in ₹</b>	0.00	<b>Fee Payable To</b>	NA	<b>Fee Payable At</b>	NA
<b>Tender Fee Exemption Allowed</b>	NA				

**EMD Fee Details**

<b>EMD Amount in ₹</b>	0.00	<b>EMD Exemption Allowed</b>	NA
<b>EMD Fee Type</b>	NA	<b>EMD Percentage</b>	NA
<b>EMD Payable To</b>	NA	<b>EMD Payable At</b>	NA

**Work /Item(s)**

<b>Title</b>	Silicon Wafer CMP Machine				
<b>Work Description</b>	Silicon Wafer CMP Machine				
<b>Pre Qualification Details</b>	Please refer Tender documents.				
<b>Tender Value in ₹</b>		<b>Product Category</b>	Miscellaneous Goods	<b>Sub category</b>	NA
<b>Contract Type</b>	Tender	<b>Bid Validity(Days)</b>	90	<b>Period Of Work(Days)</b>	21
<b>Location</b>	Department of Physics IIT Madras	<b>Pincode</b>	600036	<b>Pre Bid Meeting Place</b>	NA
<b>Pre Bid Meeting Address</b>	NA	<b>Pre Bid Meeting Date</b>	NA	<b>Bid Opening Place</b>	Department of Physics IIT Madras

**Critical Dates**

<b>Publish Date</b>	23-Oct-2018 05:30 PM	<b>Bid Opening Date</b>	14-Nov-2018 04:30 PM
<b>Document Download / Sale Start Date</b>	23-Oct-2018 05:35 PM	<b>Document Download / Sale End Date</b>	14-Nov-2018 03:00 PM
<b>Clarification Start Date</b>	NA	<b>Clarification End Date</b>	NA
<b>Bid Submission Start Date</b>	23-Oct-2018 05:40 PM	<b>Bid Submission End Date</b>	14-Nov-2018 03:00 PM

**Tender Documents**

NIT Document	S.No	Document Name	Description	Document Size (in KB)
		1	Tendernotice_1.pdf	As per tender document

  

Work Item Documents	S.No	Document Type	Document Name	Description	Document Size (in KB)
		1	Tender Documents	Open Tender - Silicon Wafer CMP Machine.pdf	As per tender document

**Tender Inviting Authority**

<b>Name</b>	V Sathyanarayanan
<b>Address</b>	Senior Manager, Project Purchase, ICSR Building 2nd floor, I.I.T. Madras, Chennai 600 036.

**Tender Creator Details**

<b>Created By</b>	Sathyanarayanan V
<b>Designation</b>	Senior Manager, Project Purchase
<b>Created Date</b>	23-Oct-2018 05:05 PM